PRODUCT SPECIFICATION

2.8" TN TFT LCD MODULE MODEL: T028240320-A6TMR-050 Ver:1.0

< >> Preliminary Specification

< >> Finally Specification

CUSTOMER'S APPROVAL						
CUSTOMER:	CUSTOMER:					
SIGNATURE: DATE:						

APPROVED	PM	PD	PREPARED
BY	REVIEWED	REVIEWED	BY

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2017.08.08	ZFY	Initial Release	

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver lcs, a touch panel and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	2.8"	
LCD type	TN TFT	
Display Mode	Transmissive /Normally white	
Resolution	240 RGB x 320	Pixels
View Direction	6 O'clock	Best Image
Gray Scale Inversion Direction	12 clock	
Module Outline	50.00(H) x 69.20(V) x 3.80(T) (Note1)	mm
Active Area	43.2 (H) x 57.6 (V)	mm
Pixel Size	180 x180	um
Pixel Arrangement	R.G.B. Vertical Stripe	
Polarizer Surface Treatment	Anti-glare	
Display Colors	262K	
Interface	8-bit Parallel CPU interface	
With or without touch panel	With	
Driver IC	ILI9341V	-
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	22	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25°C

Item		Symbol	Min.	Max.	Unit
Supply Voltage	Logic	IOVCC	-0.3	4.6	V
Supply Voltage	Analog	VCC	-0.3	4.6	V
Storage temperature		T _{STG}	-30	+80	°C
Operating temperature		T _{OP}	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	
Cupply Voltage	Logic	IOVCC	1.65	1.8/2.8	3.3	V
Supply Voltage	Analog	VCC	2.4	2.8	3.3	V
Logic Low input voltage		V _{IL}	GND	-	0.3*IOVCC	V
Logic High input voltage	V _{IH}	0.7*IOVCC	-	IOVCC	V	
Logic Low output voltage		V _{OL}	GND	-	0.2*IOVCC	V
Logic High output voltage		V _{OH}	0.8*IOVCC	-	IOVCC	V
Current Consumption	Logic	loo livi		(10)		mΛ
All Black	Analog	ICC+ IIN	-	(10)	-	mA

5. Backlight Characteristic

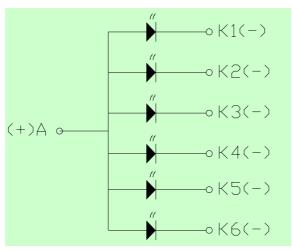
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I _F =15mA/LED	2.8	3.2	3.4	V
Forward Current	lF	Ta=25 °C, V _F =3.2V/LED	-	90	-	mA
Power dissipation	PD		-	288	-	mW
LED Life Time(25 °C)	-	-	(20,000)	-	-	hrs
Uniformity	Avg	Avg			-	%
Drive method	Constant current					
LED Configuration		6 White LED	os in paralle	el		

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25 \pm 2 °C,60%RH \pm 5%.

5.2. Backlighting circuit



6. Touch Screen Panel Specifications

6.1 Electrical Characteristics

Item	Min.	Тур.	Max.	Unit	Note
Linearity	-1.5	-	1.5	%	Analog X and Y directions
Terminal resistance	150	-	550	Ω	X(Film side)
reminal resistance	300	-	850	Ω	Y(Glass side)
Insulation resistance	20	-	-	MΩ	DC ≤10V
Voltage	-	5	10	V	DC
Chattering	-	-	10	ms	

Caution (1): Do not operate it with a thing except a polyacetal pen (tip R0.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

6.2 Mechanical & Reliability Characteristics

Item	Min.	Тур.	Max.	Unit	Note
Activation force	30	-	120	g	(1)
Durability-surface scratching	Write 20,000	-	-	characters	(2)
Durability-surface pitting	1,000,000	-	-	touches	(3)
Surface hardness	3	1	-	Н	

Note (1) Stylus pen Input: R0.8mm polyacetal pen or Finger

Note (2) Measurement for Surface area

Force: 150-250gfSpeed: 60mm/sec

- Stylus: R0.8 polyacetal pen or Finger

Note (3) Pit 1,000,000 times on the Film with a R3.75 silicon rubber.

Force: Force: 2.45NSpeed: 3times/sec

7. Optical Characteristics

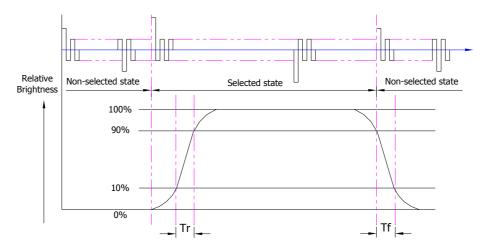
7.1. Optical Characteristics

Ta=25°C, V_{DD} =2.8V, TN LC+ Polarizer

					S	pecificati	on	
	Item		Symbol Condition		Min.	Тур.	Max.	Unit
	Luminar	nce on						
(a)	TFT(I_f =15	imA/LED)	Lv	Normally	220	280	-	cd/m²
lod	Contrast rati	o(See 7.3)	CR	viewing angle $\theta x = \phi y = 0^{\circ}$	400	500	-	
sive M	Response time (See 7.2)		TR+TF	θx – ψΥ –υ	-	16	32	ms
mis	Contrast ration (See 7.5) Contrast ration (See 7.5) Chromaticity Transmissive (See 7.5)	Red	XR		0.553	0.603	0.653	
Sus		Reu	YR		0.307	0.357	0.407	
Ţ		Green	Xg		0.237	0.287	0.337	
nC	Chromaticity Transmissive	016611	Yg		0.559	0.609	0.659	
ht ((See 7.5)	Blue	Хв		0.096	0.146	0.196	
clig	(000 7.0)	Dide	YΒ		0.035	0.085	0.135	
ac		White	Xw		0.218	0.268	0.318	
<u> </u>		VVIIILE	Yw		0.258	0.308	0.358	
	Angle	Horizontal	θx+		50	60	-	
		rionzonial	θх-	Center CR≥10	50	60	-	Dog
		Vortical	φY+	Center CR210	50	60	-	Deg.
		Vertical	фҮ-		40	50		
	NTSC Ratio	o(Gamut)			-	60	-	%

7.2. Definition of Response Time

7.2.1. Normally Black Type (Negative)



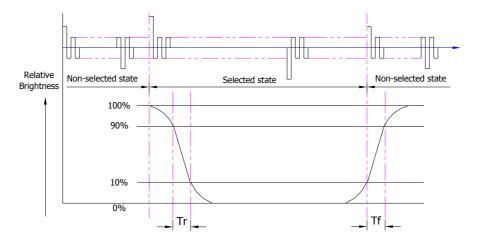
Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to

non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

7.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

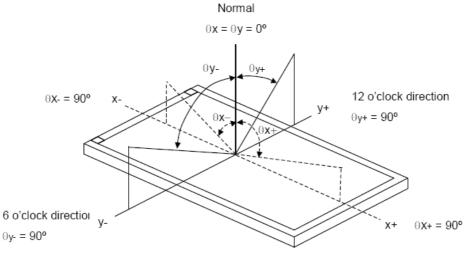
7.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent		
Measuring Point Diameter	3mm//1mm		
Measuring Point Location	Active Area centre point		
Toot nottorn	A: All Pixels white		
Test pattern	B: All Pixel black		
Contrast setting	Maximum		

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

7.4. Definition of Viewing Angles

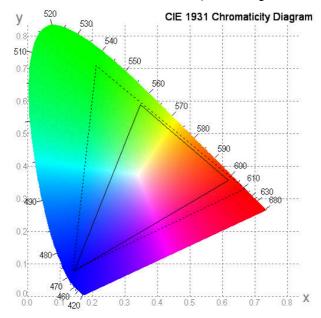


Measuring machine: LCD-5100 or EQUI

7.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

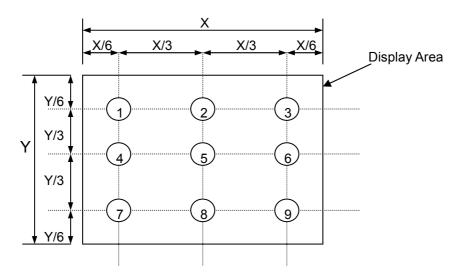


7.6. Definition of Surface Luminance, Uniformity and Transmittance

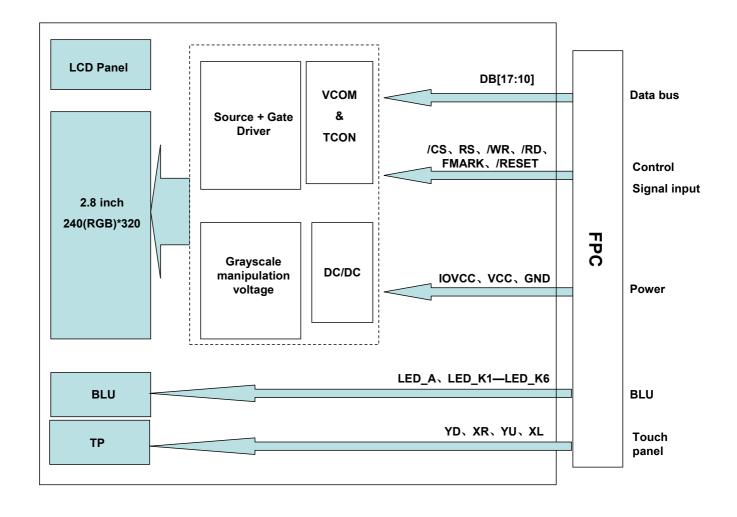
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 7.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 7.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 7.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



8. Block Diagram and Power Supply

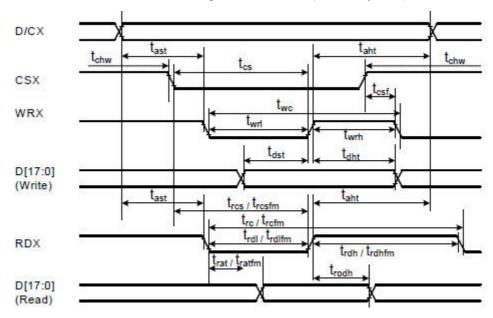


9. Interface Pins Definition

No.	Symbol	Function	Remark
1	FMARK	Tearing effect output pin	
2	IOVCC	Digital Supply Power	
3	VCC	Analog Supply Power	
4	/CS	Chip Select Signal (Low: active)	
5	RS	Data/Commander Selection	
6	/WR	Write Signal	
7	/RD	Read Signal	
8	/RESET	Reset Signal	
9	GND	Ground	
10	NC	No Connection	
11	GND	Ground	
12	NC	No Connection	
13	GND	Ground	
14	NC	No Connection	
15	GND	Ground	
16	NC	No Connection	
17	DB10	Data Bus	
18	DB11	Data Bus	
19	DB12	Data Bus	
20	DB13	Data Bus	
21	DB14	Data Bus	
22	DB15	Data Bus	
23	DB16	Data Bus	
24	DB17	Data Bus	
25	LCD_ID	No Connection	
26	YD	Touch panel terminal	
27	XR	Touch panel terminal	
28	YU	Touch panel terminal	
29	XL	Touch panel terminal	
30	LED_A	Led Anode	
31	LED_K1	Led Cathode	
32	LED_K2	Led Cathode	
33	LED_K3	Led Cathode	
34	LED_K4	Led Cathode	
35	LED_K5	Led Cathode	
36	LED_K6	Led Cathode	
37	NC	No Connection	

10. AC Characteristics

Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080-II system)

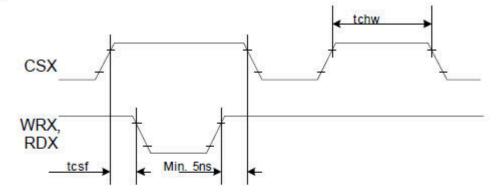


Signal	Symbo	Parameter	min	max	Unit	Description
DOV	tast	Address setup time	0	20	ns	
DCX	taht	Address hold time (Write/Read)	0	2	ns	
	tchw	CSX "H" pulse width	0	- 1	ns	
	tcs	Chip Select setup time (Write)	15	150	ns	
CSX	trcs	Chip Select setup time (Read ID)	45		ns	
	trcsfm	Chip Select setup time (Read FM)	355	100 N	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	17.5	ns	
7	twc	Write cycle	66	(- 6)	ns	
WRX	twrh	Write Control pulse H duration	15	(* 5)	ns	
	twrl	Write Control pulse L duration	15	4	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
RDX (FM)	trdhfm	Read Control H duration (FM)	90	920	ns	
	trdlfm	Read Control L duration (FM)	355	920	ns	
i i	trc	Read cycle (ID)	160	120	ns	
RDX (ID)	trdh	Read Control pulse H duration	90	2	ns	
	trdl	Read Control pulse L duration	45	20	ns	
D147-03	tdst	Write data setup time	10		ns	
D[17:0],	tdht	Write data hold time	10	150	ns	F
D[17:10]&D[8:1],	trat	Read access time	-	40	ns	For maximum CL=30pF
D[17:10],	tratfm	Read access time	15	340	ns	For minimum CL=8pF
D[17:9]	trod	Read output disable time	20	80	ns	1

Note: Ta = -30 to 70 °C, VDDI = 1.65V to 3.3V, VCI = 2.5V to 3.3V, VSS = 0V.

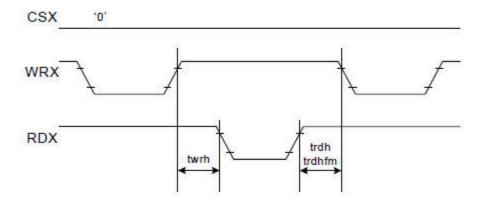


CSX timings:



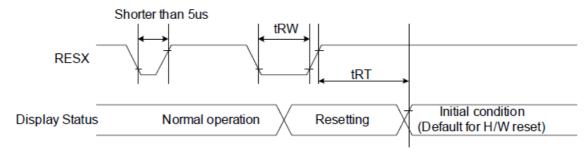
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

11. Reset Timing

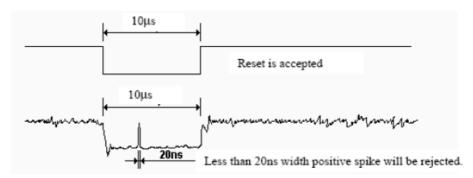


Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	4DT	Deset seves		5 (note 1,5)	mS
	tRT	Reset cancel		120 (note 1,6,7)	mS

- Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

- Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.
- Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



- Note 5: When Reset applied during Sleep In Mode.
- Note 6: When Reset applied during Sleep Out Mode.
- Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

12. Quality Assurance

12.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

12.2. Standard for Quality Test

12.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

12.2.2 Sampling Criteria:

Visual inspection: AQL 1.5% Electrical functional: AQL 0.65%.

12.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

12.3. Nonconforming Analysis & Disposition

- 12.3.1 Nonconforming analysis:
 - 12.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.
 - 12.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 12.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.
- 12.3.2 Disposition of nonconforming:
 - 12.3.2.1 Non-conforming product over PPM level will be replaced.
 - 12.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

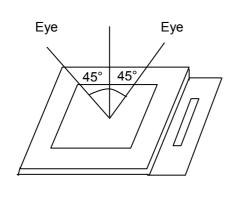
12.4. Agreement Items

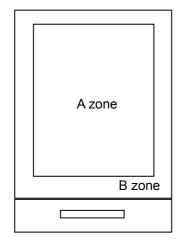
Shall negotiate with customer if the following situation occurs:

- 12.4.1 There is any discrepancy in standard of quality assurance.
- 12.4.2 Additional requirement to be added in product specification.
- 12.4.3 Any other special problem.

12.5. Standard of the Product Visual Inspection

- 12.5.1 Appearance inspection:
 - 12.5.1.1 The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
 - 12.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
 - 12.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,



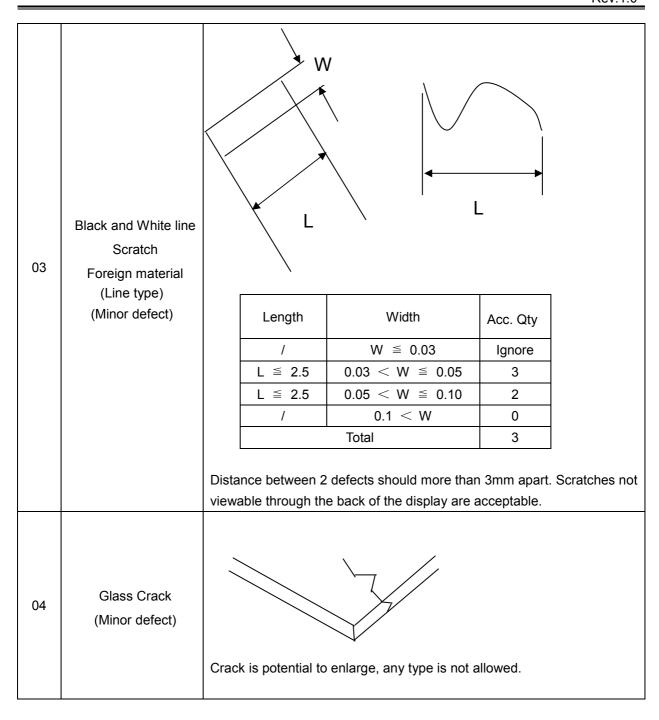


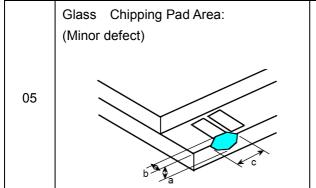
12.5.2 Basic principle:

- 12.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.
- 12.5.2.2 New item must be added on time when it is necessary.

12.6. Inspection Specification

No.	Item	Criteria (Unit: mm)				
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	ϕ = (a + b)/2	Size $\phi \leqslant 0.10$ $0.10 < \phi \leqslant 0.$ $0.15 < \phi \leqslant 0.$ $0.25 < \phi$ $Total$	15 25 2	Acc. Qty Ignore 2 1 0 no include p≤ 0.10	
02	Electrical Defect (Minor defect)	Bright dot Dark dot Total dot N	ay Area 0 ≤2 ≤2 sible through 5% atch and foreign		Note1 Note 2 ds to item 1.	





Length and Width	Acc. Qty
c > 3.0, b< 1.0	1
c< 3.0, b< 1.0	3
a <glass td="" thick<=""><td>kness</td></glass>	kness

	Glass Chipping Rear of Pad Area: (Minor defect)			
			Length and Width	Acc. Qty
			c > 3.0, b< 1.0	1
06			c< 3.0, b< 1.0	2
			c< 3.0, b< 0.5	4
	6		a <glass td="" thicl<=""><td>kness</td></glass>	kness
	D Va			
	Glass Chipping Except Pad Area: (Minor defect)			
	(Willion delecty)		Length and Width	Acc. Qty
			c > 3.0, b< 1.0	1
07			c< 3.0, b< 1.0	2
	b		c< 3.0, b< 0.5	4
			a <glass td="" thicl<=""><td>kness</td></glass>	kness
	a 🔨			
	Glass Corner Chipping: (Minor defect)			
	(Willion defect)		Length and Width	Acc. Qty
			c < 3.0, b< 3.0	Ignore
08			a <glass td="" thicl<=""><td></td></glass>	
			4 101000 111101	11000
	b			
09	Glass Burr: (Minor defect)	Glass I		Acc. Qty Ignore semble and module

10	FPC Defect: (Minor defect)		10.1 Dent, pinhole v (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, o	unacceptable.	nd distortion.
11	Bubble on Polarizer (Minor defect)		Diameter $\phi \leqslant 0.20$ $0.20 < \phi \leqslant 0.30$ $0.30 < \phi \leqslant 0.50$ $0.50 < \phi$	Acc. Qty Ignore 4 1 None	
12	Dent on Polarizer (Minor defect)		Diameter $\phi \leqslant 0.20$ $0.20 < \phi \leqslant 0.30$ $0.30 < \phi \leqslant 0.50$ $0.50 < \phi$	Acc. Qty Ignore 4 1 None	
13	Bezel	13.1 No rust, distortion on the Bezel.13.2 No visible fingerprints, stains or other contamination.			
14	Touch Panel	D: Diameter W: width L: length 14.1 Spot: D<0.25 is acceptable 0.25 ≤ D ≤ 0.4 2dots are acceptable and the distance between defects should more than 10 mm. D>0.4 is unacceptable 14.2 Dent: D>0.40 is unacceptable 14.3 Scratch: W≤0.03, L≤10 is acceptable, 0.03 <w≤0.10, 10="" 2="" acceptable="" between="" defects="" distance="" is="" l≤10="" mm.="" more="" should="" than="" w="">0.10 is unacceptable.</w≤0.10,>			
15	LCD Ripple	Touch the touch panel, cannot see the LCD ripple. Pen: R 0.8mm silicon rubber. Operation Force:120g			
16	РСВ	16.1 No distortion or contamination on PCB terminals. 16.2 All components on PCB must same as documented on the BOM/component layout. 16.3 Follow IPC-A-600F.			

17	Soldering	Follow IPC-A-610C standard
18	Electrical Defect (Major defect)	The below defects must be rejected. 18.1 Missing vertical / horizontal segment, 18.2 Abnormal Display. 18.3 No function or no display. 18.4 Current exceeds product specifications. 18.5 LCD viewing angle defect. 18.6 No Backlight. 18.7 Dark Backlight. 18.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

12.7. Classification of Defects

- 12.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 12.7.2 Two minor defects are equal to one major in lot sampling inspection.

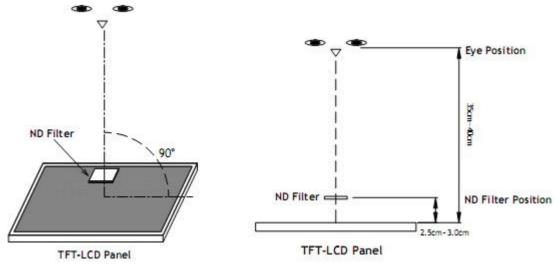
12.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

12.9. Packaging

- 12.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.
- 12.9.2 Modules inside package box should have compliant mark.
- 12.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

13. Reliability Specification

No	ltem	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: \pm 8KV 150pF/330 Ω 5 times	2	GB/T17626.2
	Lieutical Static Discharge	Contact: \pm 4KV 150pF/330 Ω 5 times	2	-2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value.

Note3. Do not display the fixed pattern for a long time because it may develop image sticking

14. Precautions and Warranty

14.1 Safety

- 14.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 14.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

14.2. Handling

- 14.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 14.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

14.3. Storage

14.3.1 Do not store the LCD module beyond the specified temperature ranges.

14.4. Metal Pin (Apply to Products with Metal Pins)

14.4.1. Pins of LCD and Backlight

14.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

14.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

14.4.1.3. Solder Wetting

Solder Pin Lead

Recommended

Solder Pin Lead

Not Recommended

14.4.2. Pins of EL

- 14.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.
- 14.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

14.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270 ~290 ℃

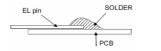
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

14.4.2.4. No horizontal press on the EL leads during soldering.

14.4.2.5. 180° bend EL leads three times is not allowed.

14.4.2.6. Solder Wetting



EL pin SOLDER PCB

Recommended

Not Recommended

14.4.2.7. The type of the solder iron:





Recommended

Not Recommended

14.4.2.8. Solder Pad



14.5. Operation

- 14.5.1. Do not drive LCD with DC voltage
- 14.5.2. Response time will increase below lower temperature
- 14.5.3. Display may change color with different temperature
- 14.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

14.6. Static Electricity

- 14.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 14.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 14.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

14.7. Limited Warranty

- 14.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 14.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used
- 14.7.3. . . After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

15. Packaging

TBD

16. Outline Drawing

